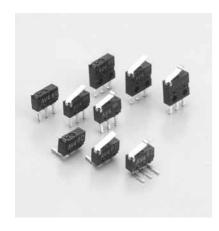
Panasonic

ideas for life

ONE OF THE SMALLEST SNAP-ACTION SWITCHES IN THE WORLD

AV4 (FU) SWITCHES



FEATURES

• Superminiature type, light-weight snap action switch

PC board terminal type (0.2g)



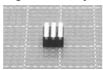
Solder terminal type with mounting holes (0.3g)

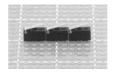


• Mechanical life of 300,000 operations minimum

Stainless steel plated silver or gold is used for actuating spring

 Switches can be mounted close together in any directions

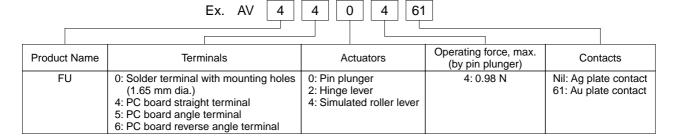




TYPICAL APPLICATIONS

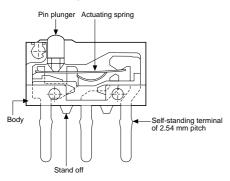
- Compact visual equipment Camera, portable VCR
- Small-sized audio equipment Cassette tape recorder, Car stereo
- Office automation equipment Light pen for personal computer, floppy disc apparatus, printer, computer

ORDERING INFORMATION

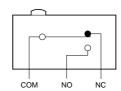


CONSTRUCTION

PC board straight terminal type



CONTACT ARRANGEMENT



PRODUCT TYPES

	Actuator	Operating	Type No.			
Type of contacts			PC board terminal			Solder terminal
Type of contacts	Acidatol	force, Max.	Straight terminal	Angle terminal	Reverse angle terminal	with mounting holes
Silver plated contact	Pin plunger	0.98 N	AV4404	AV4504	AV4604	AV4004
	Hinge lever	0.25 N	AV4424	AV4524	AV4624	AV4024
type	Simulated roller lever	0.29 N	AV4444	AV4544	AV4644	AV4044
Gold plated contact type	Pin plunger	0.98 N	AV440461	AV450461	AV460461	AV400461
	Hinge lever	0.25 N	AV442461	AV452461	AV462461	AV402461
	Simulated roller lever	0.29 N	AV444461	AV454461	AV464461	AV404461

SPECIFICATIONS

1. Contact rating

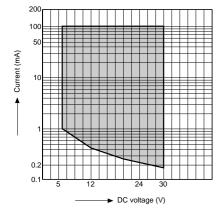
Type of contact	Resistive load (cos <i>φ</i> ≒1)
Silver plated contact	0.5A 30V DC
Gold plated contact	0.1A 30V DC

2. Characteristics

		Items	Characteristics	
	Mechanical		Min. 3 × 10 ⁵ operations (at 60 cpm)	
Life	Flactrical	Silver plated contact	Min. 2 × 10 ⁴ operations (0.5A 30V DC; at 20 cpm)	
	Electrical	Gold plated contact	Min. 2 × 10 ⁵ operations (0.1A 30V DC; at 20 cpm)	
Insulation re	sistance		Min. 100 MΩ (250V DC by insulation resistance meter)	
Between non-continuous terminals		ontinuous terminals	500V AC for 1 min.	
Voltage withstand	Between each t	terminal and other exposed metal parts	500V AC for 1 min.	
Willistand	Between each t	terminal and ground	500V AC for 1 min.	
Vibration resistance Pin plunger type Lever type		Pin plunger type	10 to 55 Hz at single amplitude of 0.75mm (contact opening: max. 1 msec.)	
		Lever type	10 to 55 Hz at single amplitude of 0.15mm (contact opening: max. 1 msec.)	
Shock resistance Pin plunger type		Pin plunger type	Min. 294m/s² (contact opening: max. 1 msec.)	
Snock resist	ance	Lever type	Min. 147m/s² (contact opening: max. 1 msec.)	
Contact resi	stance (initial val	ue)	Max. 200 m Ω (by YHP4328A)	
Allowable operation speed			0.1mm/s to 500mm/s (pin plunger type)	
Mechanical max. switching frequency		equency	60 operations/min.	
Ambient ten	nperature		-25 to +80°C (Not freezing below 0°C)	
Unit weight			PC board terminal type: Approx. 0.2g Solder terminal with mounting holes type: Approx. 0.3g	

DATA

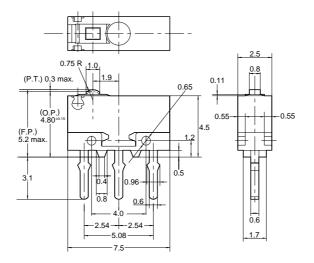
Gold plate contact type Range of low-level current and voltage (Reference only)



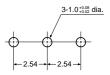
DIMENSIONS

1. PC board terminal Straight terminal Pin plunger type





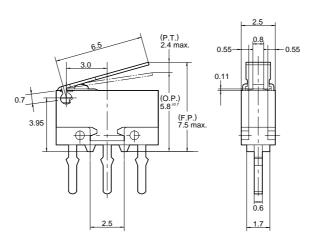
PC board pattern



0.3 max.
0.1 max.
0.1 min.
4.8±0.15
5.2 max.

Hinge lever type



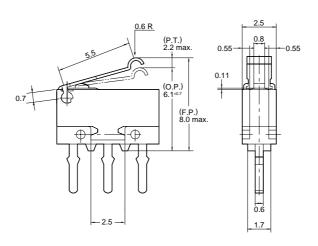


Pretravel	2.4 max.
Movement Differential	0.7 max.
Overtravel	0.4 min.
Operating Position	5.8±0.7
Free Position	7.5 max.

Note: All other dimensions are the same as those of pin plunger type.

Simulated roller lever type



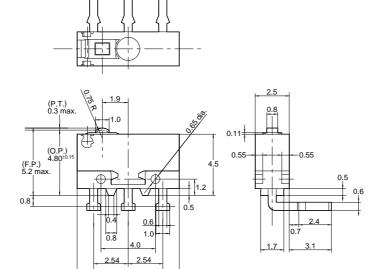


Pretravel	2.2 max.
Movement Differential	0.7 max.
Overtravel	0.3 min.
Operating Position	6.1±0.7
Free Position	8.0 max.

Note: All other dimensions are the same as those of pin plunger type.

2. Angle terminal Right angle terminal Pin plunger type





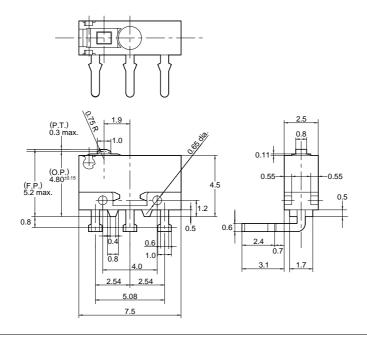
5.08

Pretravel	0.3 max.
Movement Differential	0.1 max.
Overtravel	0.1 min.
Operating Position	4.8±0.15
Free Position	5.2 max.

Note: All other dimensions of hinge lever type and simulated roller lever type are the same as those of straight terminal types.

Left angle terminal Pin plunger type





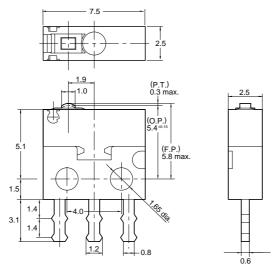
Pretravel	0.3 max.
Movement Differential	0.1 max.
Overtravel	0.1 min.
Operating Position	4.8±0.15
Free Position	5.2 max.

Note: All other dimensions of hinge lever type and simulated roller lever type are the same as those of straight terminal types.

3. Solder terminal with mounting holes

Pin plunger type

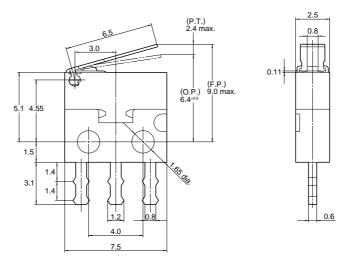




Pretravel	0.3 max.
Movement Differential	0.1 max.
Overtravel	0.1 min.
Operating Position	5.4±0.15
Free Position	5.8 max.

Hinge lever type mm General tolerance: ±0.15



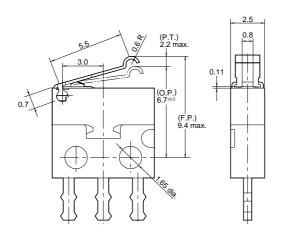


Pretravel	2.4 max.
Movement Differential	0.7 max.
Overtravel	0.4 min.
Operating Position	6.4±0.6
Free Position	9.0 max.

Note: All other dimensions are the same as those of pin plunger type.

Simulated roller lever type





Pretravel	2.2 max.
Movement Differential	0.7 max.
Overtravel	0.3 min.
Operating Position	6.7±0.5
Free Position	9.4 max.

Note: All other dimensions are the same as those of pin plunger type.

NOTES

1. Mounting

- 1) After mounting and wiring, the insulation distance between ground and each terminal should be confirmed as sufficient.
- 2) When the operation object is in the free position, force should not be applied to the actuator or to the pin plunger. Also force should be applied to the pin plunger from vertical direction to the switch.
- 3) In setting the movement after operation, the over-travel should be set within the range of the specified O.T. value.
- 4) In fastening the switch body, use the M1.4 screw, with tightening torque of not more than 0.098 N·m.

2. Soldering

- 1) Hand soldering should be accomplished in less than 5 seconds with an iron below 18 watts. Keep the soldering tip temperature less than 320°C. Avoid applying force to the terminals.
- 2) Terminal portion must not be moved within 1 minute after soldering. Also no tensile strength of lead wires should be applied to the terminals.
- 3) When using the angle terminal type, insert an insulation separator between the switch body and the printed circuit board (Insulation separator 0.2 to 0.4mm thick) to prevent the soldering flux from flowing under the PC board.

3. Cleaning

As FU switch is not completely sealed construction, avoid cleaning.

4. Selection of switch

When specifying FU switches, allow ±20% to the listed operating characteristics.

- 5. Avoid using and keeping switches in the following conditions:
- In corrosive gases
- In a dusty environment
- Where silicon atmosphere prevails
- When switching low-level circuits (max. 100 mA), gold plate contact types are recommended.
- 7. When using the lever type, avoid applying force from the reverse and side direction of actuating.